

L Number	Hits	Search Text	DB	Time stamp
1	2	heat adj conductive adj base same heat adj insulating adj cover	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 07:36
2	2	heat adj conductive adj base and heat adj insulating adj cover	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 07:37
3	2	heat adj conductive adj base and energy adj conversion	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 07:38
5	814	heat adj insulating adj cover	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 07:39
6	2	(heat adj insulating adj cover) and energy adj conversion	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 07:40
7	68	(heat adj insulating adj cover) and sealed	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 07:40
4	225	heat adj conductive adj base	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 07:45
8	0	(heat adj conductive adj base ) and enclosue	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 07:47
9	33	(heat adj conductive adj base ) and sealed	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/24 07:47